14 May 2024

**Product data sheet** 

## 1. General description

The NSF030120D7A0 is a Silicon Carbide based 1200 V power MOSFET in a well-established 7-pin TO-263 plastic package for surface mounting PCB technology. The excellent  $R_{DSon}$  temperature stability combined with its fast switching speed makes it a product of choice in high power and high voltage industrial applications like E-vehicle charging infrastructure, photovoltaic inverters and motor drives.

### 2. Features and benefits

- Excellent R<sub>DSon</sub> temperature stability
- Very low switching losses
- Fast reverse recovery
- · Fast switching speed
- Temperature independent turn-off switching losses
- · Very fast and robust intrinsic body diode
- · Faster commutation and improved switching due to the additional Kelvin source pin

## 3. Applications

- E-vehicle charging infrastructure
- Photovoltaic inverters
- Switch mode power supply
- Uninterruptable power supply
- Motor drives

### 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage			-	-	1200	V
$V_{GS}$	gate-source voltage		[1]	-10	-	22	V
I <sub>D</sub>	drain current	T <sub>c</sub> = 25 °C	[2]	-	-	67	Α
		T <sub>c</sub> = 100 °C	[2]	-	-	47	Α
I <sub>DM</sub>	peak drain current	pulsed; t <sub>p</sub> limited by T <sub>j</sub> (max)	[3]	-	-	160	Α
Static characte	eristics						
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = 18 \text{ V}; I_D = 40 \text{ A}; T_j = 25 ^{\circ}\text{C}$		-	30	45	mΩ

- [1] Recommended turn off gate voltage is -5 V to 0 V. Recommended turn on gate voltage is 15 V to 18 V. Do not use with  $V_{GSon}$  < 13 V.
- [2] Limited by the maximum values of  $T_j$ ,  $R_{th(j-c)}$  and  $R_{DSon}(T_j)$ .
- [3] Designed value (not tested).



# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	mb	
2	KS	kelvin source		
3 to 7	S	source		D L
mb	D	mounting base; connected to drain	TO-263-7 (SOT8070-1)	G KS S aaa-036675

# 6. Ordering information

### **Table 3. Ordering information**

Type number			
	Name	Description	Version
NSF030120D7A0	TO-263-7	plastic single-ended surface-mounted package; 7 leads	SOT8070-1

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
NSF030120D7A0	30120D7A0

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>DS</sub>	drain-source voltage			-	1200	V
V <sub>GS</sub>	gate-source voltage		[1]	-10	22	V
I <sub>D</sub>	drain current	T <sub>c</sub> = 25 °C	[2]	-	67	Α
		T <sub>c</sub> = 100 °C	[2]	-	47	Α
I <sub>DM</sub>	peak drain current	pulsed; t <sub>p</sub> limited by T <sub>j</sub> (max)	[3]	-	160	Α
P <sub>tot</sub>	total power dissipation	T <sub>c</sub> = 25 °C	[2]	-	306	W
T <sub>j</sub>	junction temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-55	150	°C
T <sub>sld(M)</sub>	peak soldering temperature			-	260	°C
Source-drai	n diode			1		
I <sub>S</sub>	source current	T <sub>c</sub> = 25 °C	[2]	-	54	Α
I <sub>SM</sub>	peak source current	pulsed; limited by T <sub>j</sub> (max)	[3]	-	120	Α

<sup>[1]</sup> Recommended turn off gate voltage is -5 V to 0 V. Recommended turn on gate voltage is 15 V to 18 V. Do not use with V<sub>GSon</sub> < 13 V.

## 9. Thermal characteristics

### **Table 6. Thermal characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-c)</sub>	thermal resistance from junction to case		-	0.4	0.49	K/W

<sup>[2]</sup> Limited by the maximum values of  $T_j$ ,  $R_{th(j-c)}$  and  $R_{DSon}(T_j)$ .

<sup>[3]</sup> Designed value (not tested).

# 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static chara	acteristics						
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	$I_D$ = 1 mA; $V_{GS}$ = 0 V; $T_j$ = 25 °C		1200	-	-	V
V <sub>GS(th)</sub>	gate-source threshold	$I_D = 4 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$	[1]	1.7	2.3	2.9	V
	voltage	$I_D = 20 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$	[1]	-	2.77	-	V
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = 1200 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C		-	-	100	μΑ
I <sub>GSS</sub>	gate leakage current	V <sub>GS</sub> = 22 V; V <sub>DS</sub> = 0 V; T <sub>j</sub> = 25 °C		-	-	100	nA
		$V_{GS} = -10 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
R <sub>DSon</sub>	drain-source on-state	V <sub>GS</sub> = 15 V; I <sub>D</sub> = 40 A; T <sub>j</sub> = 25 °C		-	40	-	mΩ
	resistance	V <sub>GS</sub> = 15 V; I <sub>D</sub> = 40 A; T <sub>j</sub> = 175 °C		-	53	-	mΩ
		V <sub>GS</sub> = 18 V; I <sub>D</sub> = 40 A; T <sub>j</sub> = 25 °C		-	30	45	mΩ
		V <sub>GS</sub> = 18 V; I <sub>D</sub> = 40 A; T <sub>j</sub> = 175 °C		-	49	-	mΩ
9 <sub>fs</sub>	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 40 \text{ A}; T_j = 25 ^{\circ}\text{C}$		-	19	-	S
R <sub>G(int)</sub>	internal gate resistance	f = 0.5 MHz; T <sub>j</sub> = 25 °C		-	2.3	-	Ω
Dynamic ch	naracteristics		'				
Q <sub>G(tot)</sub>	total gate charge	$V_{DD}$ = 800 V; $I_{D}$ = 40 A; $V_{GS}$ = -5/+18 V; $I_{J}$ = 25 °C		-	113	-	nC
Q <sub>GS</sub>	gate-source charge			-	44	-	nC
$Q_{GD}$	gate-drain charge			-	34	-	nC
C <sub>iss</sub>	input capacitance	$V_{DD}$ = 800 V; f = 0.5 MHz; $V_{GS}$ = 0 V;		-	2600	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C		-	136	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	6	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DD}$ = 800 V; $I_{D}$ = 40 A; $R_{G(ext)}$ = 2.2 $\Omega$ ;		-	17	-	ns
t <sub>r</sub>	rise time	$L_L = 82 \mu H; V_{GS} = -5/+18 V; T'_j = 25 °C$		-	16	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	23	-	ns
t <sub>f</sub>	fall time			-	7	-	ns
E <sub>on</sub>	turn-on switching loss			-	405	-	μJ
E <sub>off</sub>	turn-off switching loss			-	96	-	μJ
Source-dra	in diode		•	'			
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 40 A; V <sub>GS</sub> = -5 V; T <sub>j</sub> = 25 °C		-	4.4	-	V
t <sub>rr</sub>	reverse recovery time	V <sub>DD</sub> = 800 V; I <sub>S</sub> = 40 A; dI <sub>S</sub> /dt = 8284 A/		-	7	-	ns
Q <sub>r</sub>	recovered charge	μs; V <sub>GS</sub> = -5 V; T <sub>j</sub> = 25 °C		-	143	-	nC

<sup>[1]</sup> Measured according to JEP183.

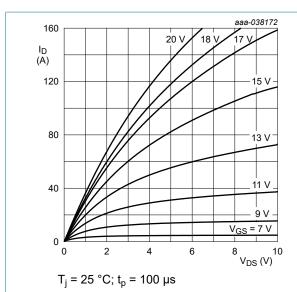


Fig. 1. Output characteristics: drain current as a function of drain-source voltage; typical values

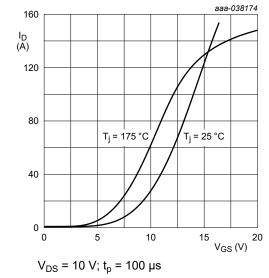


Fig. 3. Transfer characteristics: drain current as a function of gate-source voltage; typical values

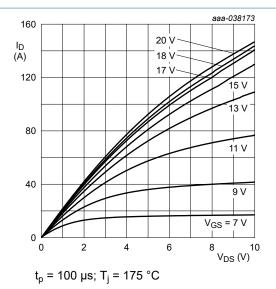


Fig. 2. Output characteristics: drain current as a function of drain-source voltage; typical values

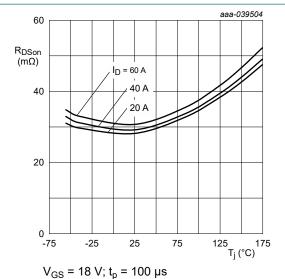


Fig. 4. Drain-source on-state resistance as a function of junction temperature; typical values

5/16

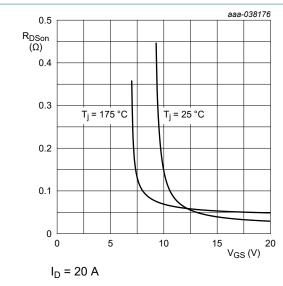


Fig. 5. Drain-source on-state resistance as a function of threshold voltage

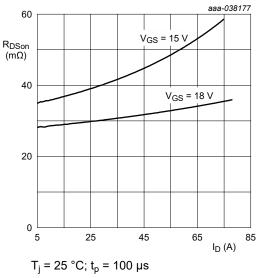


Fig. 6. Drain-source on-state resistance as a function of drain current; typical values

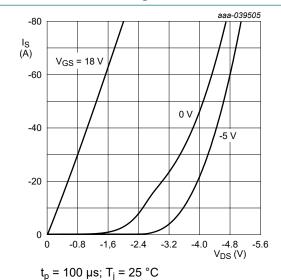


Fig. 7. Source current as a function of sourcedrain voltage; typical values (third quadrant characteristics)

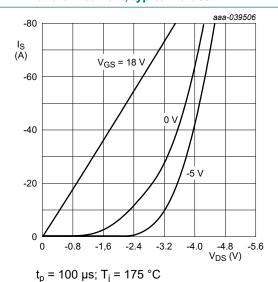


Fig. 8. Source current as a function of sourcedrain voltage; typical values (third quadrant characteristics)

6/16

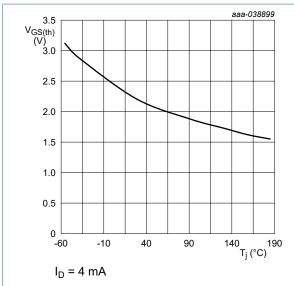
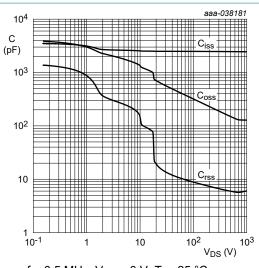


Fig. 9. Gate-source threshold voltage as a function of junction temperature; typical values



f = 0.5 MHz;  $V_{GS} = 0 \text{ V}$ ;  $T_i = 25 ^{\circ}\text{C}$ 

Fig. 10. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

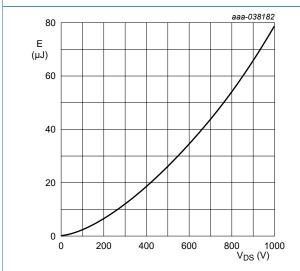
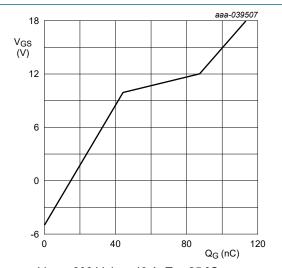


Fig. 11. C<sub>oss</sub> stored energy as a function of drain-souce voltage; typical values



 $V_{DD} = 800 \text{ V}; I_D = 40 \text{ A}; T_j = 25 \text{ °C}$ 

Fig. 12. Gate-source voltage as a function of gate charge; typical values

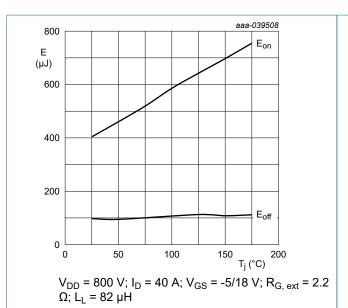


Fig. 13. Switching loss as a function of junction temperature; typical values

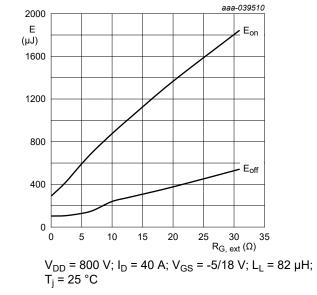
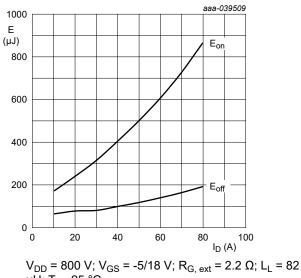


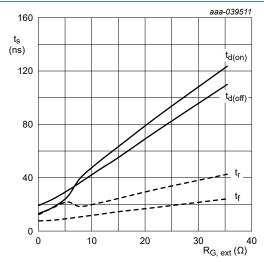
Fig. 15. Switching loss as a function of external gate resistance; typical values



μH; T<sub>j</sub> = 25 °C

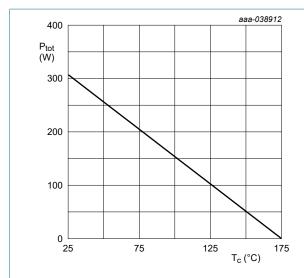
4. Switching loss as a function of drain current:

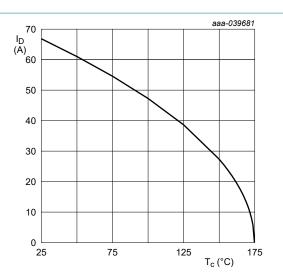
Fig. 14. Switching loss as a function of drain current; typical values



 $V_{DD}$  = 800 V;  $I_{D}$  = 40 A;  $V_{GS}$  = -5/18 V;  $L_{L}$  = 82  $\mu$ H;  $T_{i}$  = 25 °C

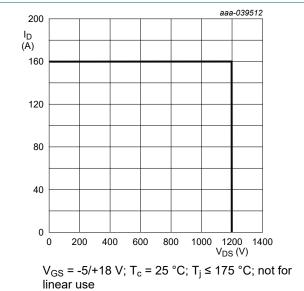
Fig. 16. Switching times as a function of external gate resistance; typical values





temperature; maximum values

Fig. 17. Power dissipation derating as a function of case Fig. 18. Continuous drain current as a function of case temperature; maximum values



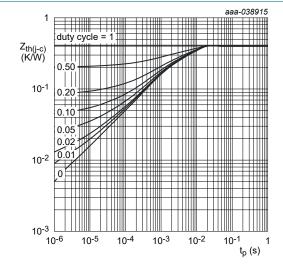


Fig. 19. Reverse bias safe operating area (RBSOA)

Fig. 20. Transient thermal impedance from junction to case as a function of pulse duration; typical values

### 11. Test information

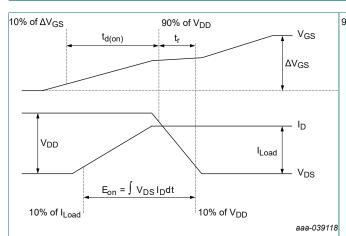


Fig. 21. Definition of switching times and losses during channel turn-on

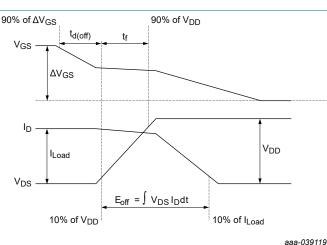


Fig. 22. Definition of switching times and losses during channel turn-off

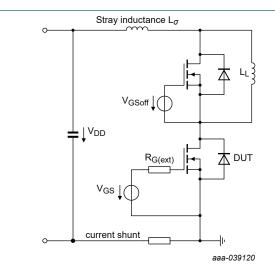


Fig. 23. Test circuit for dynamic characterization of channel and gate charge characteristics

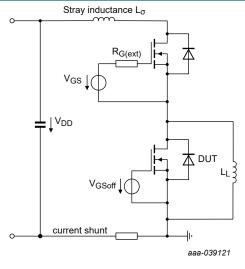


Fig. 24. Test circuit for dynamic characterization of body diode

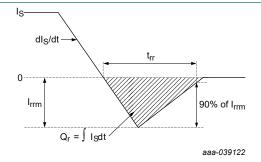


Fig. 25. Definition of dynamic characteristics of body diode

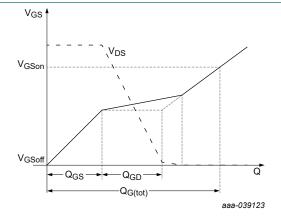
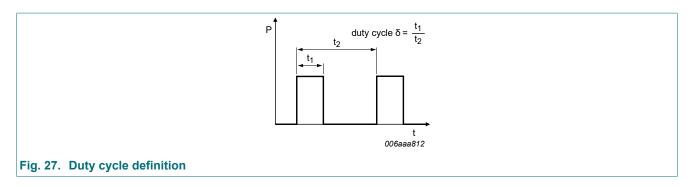


Fig. 26. Definition of gate charge characteristics



11 / 16

## 12. Package outline

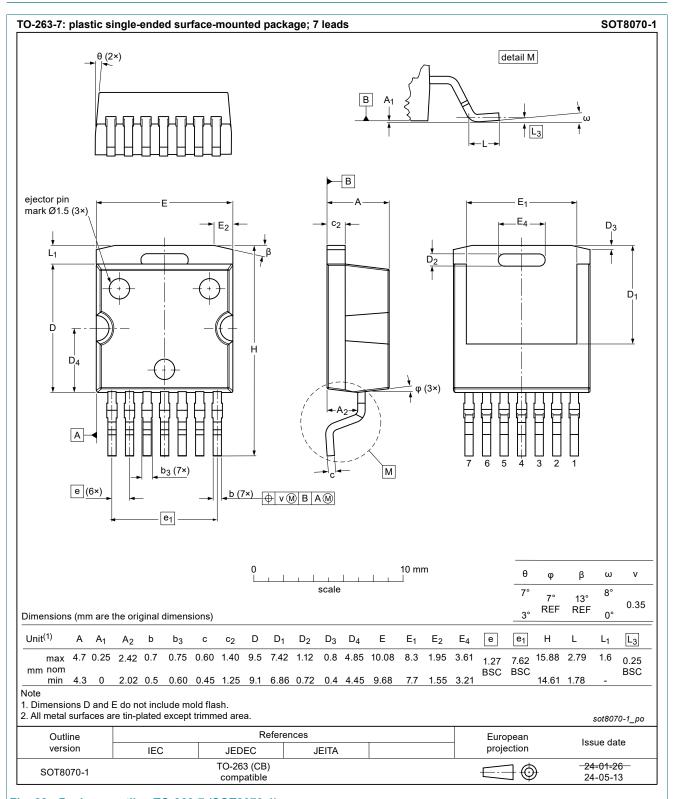
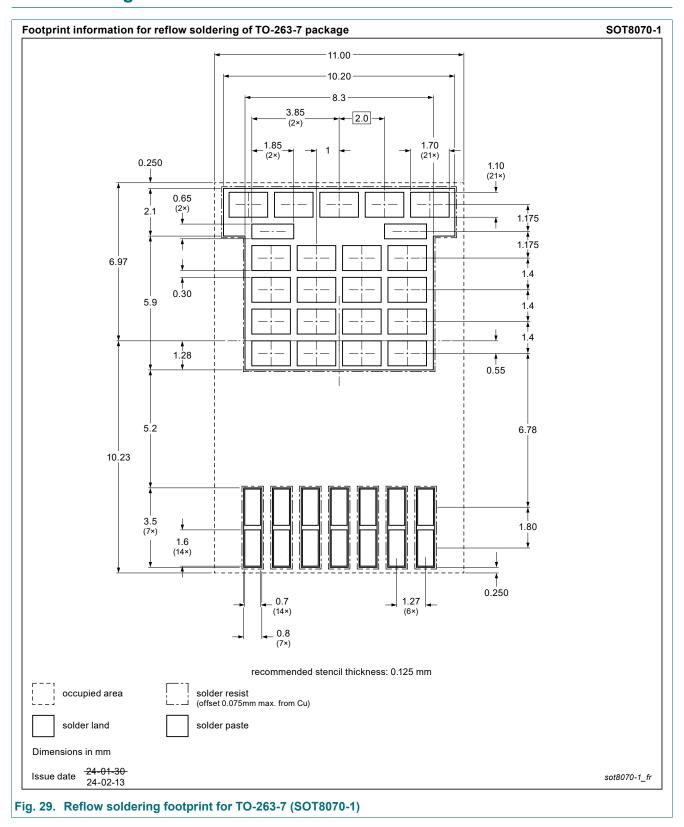


Fig. 28. Package outline TO-263-7 (SOT8070-1)

# 13. Soldering



# 14. Revision history

#### **Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
NSF030120D7A0 v.1	20240514	Product data sheet	-	-

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <a href="https://www.nexperia.com">https://www.nexperia.com</a>.

#### **Definitions**

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### **Disclaimers**

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal

injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nexperia.com/profile/terms">http://www.nexperia.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by sustained.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Nexperia's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Nexperia's standard warranty and Nexperia's product specifications.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

#### **Trademarks**

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

## **Contents**

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	3
9.	Thermal characteristics	3
10	. Characteristics	4
11.	. Test information	10
12	. Package outline	12
13	. Soldering	13
14	. Revision history	14
	Legal information	

For more information, please visit: http://www.nexperia.com For sales office addresses, please send an email to: salesaddresses@nexperia.com Date of release: 14 May 2024

<sup>©</sup> Nexperia B.V. 2024. All rights reserved

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for SiC MOSFETs category:

Click to view products by Nexperia manufacturer:

Other Similar products are found below:

NTC040N120SC1 HC3M001K170J IMBG65R048M1HXTMA1 IMW120R045M1 SCT3080ALGC11 C3M0120100K C2M1000170J
C3M0120090J C3M0065090J C3M0280090J SCT2750NYTB SCT2H12NYTB C3M0021120D C3M0016120K C3M0045065D
C3M0045065K E3M0120090J C3M0065090J-TR C3M0120100J C3M0075120J DMWS120H100SM4 DMWSH120H28SM4
DMWSH120H90SM4 DMWSH120H90SM4Q DMWSH120H28SM4Q DMWSH120H90SCT7Q DMWSH120H28SM3
DMWSH120H43SM3 DMWSH120H90SM3 DMWSH120H28SM3Q DMWSH120H90SM3Q DIF120SIC053-AQ DIW120SIC059-AQ
G2R1000MT17D G3R60MT07K G2R50MT33K G3R12MT12K G3R160MT12D G3R160MT12J-TR G3R160MT17D G3R40MT17J-TR
G3R20MT12K G3R20MT12N G3R20MT17K G3R20MT17N G3R30MT12J-TR G3R30MT12K G3R350MT12D G3R40MT12D
G3R40MT12J